

## 2.0x1.25mm SMD CHIP LED LAMP

Part Number: KPHCM-2012SURCK Hyper Red

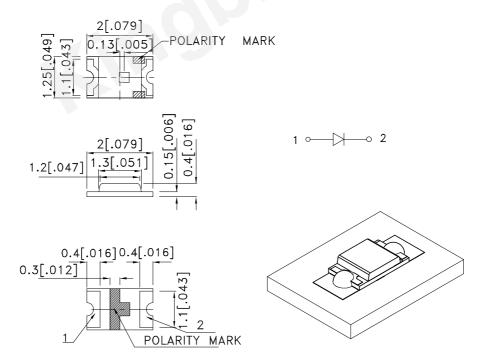
### **Features**

- 2.0X1.25mm SMT LED,0.5mm max. thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

## **Description**

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

## **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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## **Selection Guide**

| Part No.        | Dice                 | Lens Type   | Iv (mcd) [2]   Dice |      | ,     | Viewing<br>Angle [1] |
|-----------------|----------------------|-------------|---------------------|------|-------|----------------------|
|                 |                      |             | Min.                | Тур. | 201/2 |                      |
| KPHCM-2012SURCK | Lhyper Ded (AlCalaD) | Water Clear | 120                 | 230  | 110°  |                      |
|                 | Hyper Red (AlGaInP)  | Water Clear | *40 *80             | 110  |       |                      |

### Notes:

- $1. \theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
   Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device    | Тур. | Max. | Units | Test Conditions    |
|--------|--------------------------|-----------|------|------|-------|--------------------|
| λpeak  | Peak Wavelength          | Hyper Red | 645  |      | nm    | IF=20mA            |
| λD [1] | Dominant Wavelength      | Hyper Red | 630  |      | nm    | IF=20mA            |
| Δλ1/2  | Spectral Line Half-width | Hyper Red | 28   |      | nm    | Ir=20mA            |
| С      | Capacitance              | Hyper Red | 35   |      | pF    | VF=0V;f=1MHz       |
| VF [2] | Forward Voltage          | Hyper Red | 1.95 | 2.5  | V     | IF=20mA            |
| lr     | Reverse Current          | Hyper Red |      | 10   | uA    | V <sub>R</sub> =5V |

## Notes:

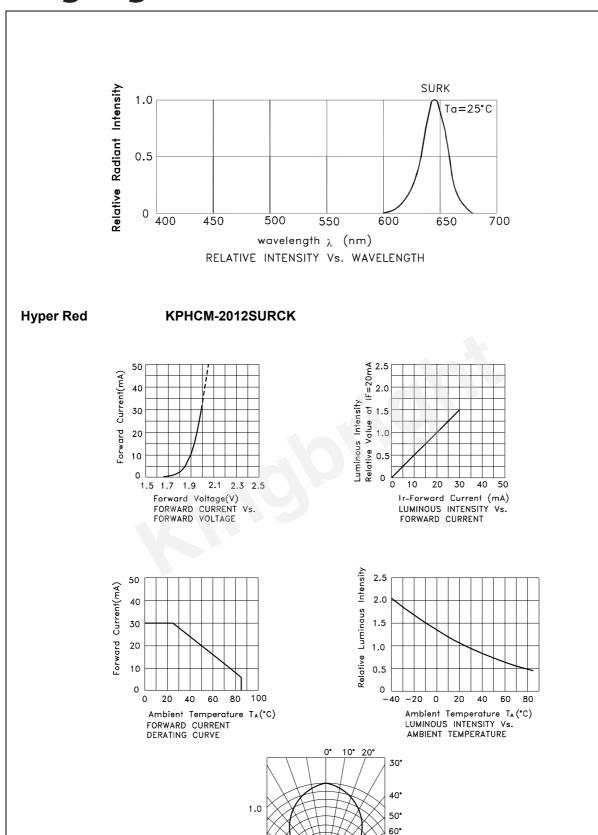
- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

| Aboolate maximum Natingo at 171 20 0 |                |       |  |  |
|--------------------------------------|----------------|-------|--|--|
| Parameter                            | Hyper Red      | Units |  |  |
| Power dissipation                    | 75             | mW    |  |  |
| DC Forward Current                   | 30             | mA    |  |  |
| Peak Forward Current [1]             | 185            | mA    |  |  |
| Reverse Voltage                      | 5              | V     |  |  |
| Operating Temperature                | -40°C To +85°C |       |  |  |
| Storage Temperature                  | -40°C To +85°C |       |  |  |
|                                      |                |       |  |  |

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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SPATIAL DISTRIBUTION

0.7

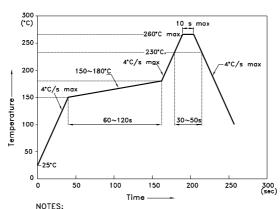
70° 80°

90°

## **KPHCM-2012SURCK**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



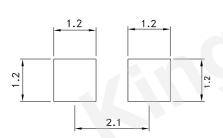
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

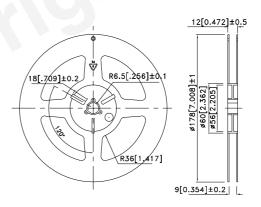
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

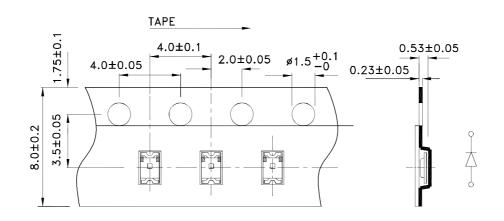


## **Tape Dimensions**

(Units: mm)

## **Reel Dimension**

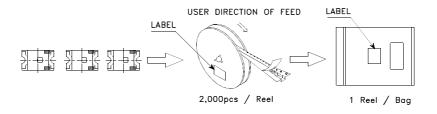


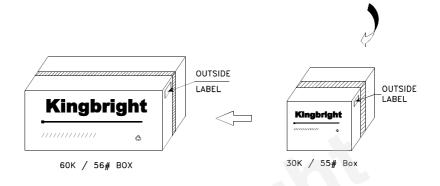


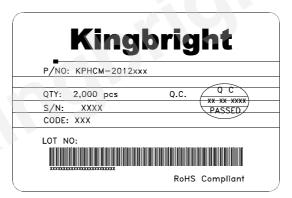
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## **PACKING & LABEL SPECIFICATIONS**

### KPHCM-2012SURCK







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